


**PRODUCT / PROCESS CHANGE NOTIFICATION**

**1. PCN basic data**

<b>1.1 Company</b>		STMicroelectronics International N.V
<b>1.2 PCN No.</b>	AMS/23/13903	
<b>1.3 Title of PCN</b>	Qualification of TFME for Assembly & Test of HTSSOP24/TSSOP24 packages	
<b>1.4 Product Category</b>	See product list	
<b>1.5 Issue date</b>	2023-01-31	

**2. PCN Team**

<b>2.1 Contact supplier</b>	
<b>2.1.1 Name</b>	KRAUSE INA
<b>2.1.2 Phone</b>	+49 89460062370
<b>2.1.3 Email</b>	ina.krause@st.com
<b>2.2 Change responsibility</b>	
<b>2.2.1 Product Manager</b>	Marcello SAN BIAGIO
<b>2.1.2 Marketing Manager</b>	Salvatore DI VINCENZO
<b>2.1.3 Quality Manager</b>	Giuseppe LISI

**3. Change**

<b>3.1 Category</b>	<b>3.2 Type of change</b>	<b>3.3 Manufacturing Location</b>
Transfer	Product transfer from one site to another site, even if test or process line is qualified	Back end : TFME

**4. Description of change**

	Old	New
<b>4.1 Description</b>	- Automotive Devices : Assembly in Amkor ATP1, Test in Muar and Amkor - Standard Devices : Assembly and Test in Amkor	- Automotive Devices : Assembly in Amkor ATP1, Test in Muar and Amkor Assembly in TFME and Test in ST Muar - Standard Devices : Assembly and Test in Amkor Assembly and Test in TFME
<b>4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?</b>	No impact	

**5. Reason / motivation for change**

<b>5.1 Motivation</b>	To increase Assembly and Test Volume Capacity for HTSSOP24 and TSSOP24 products
<b>5.2 Customer Benefit</b>	MANUFACTURING FLEXIBILITY

**6. Marking of parts / traceability of change**

<b>6.1 Description</b>	New Finished good codes
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**7. Timing / schedule**

<b>7.1 Date of qualification results</b>	2023-01-20
<b>7.2 Intended start of delivery</b>	2023-05-01
<b>7.3 Qualification sample available?</b>	Upon Request

**8. Qualification / Validation**

<b>8.1 Description</b>	13903 RER 6088-1765-W-2022_HTSSOP_TSSOP 24 assembled in TFME_ALED1262_ALED1642_STAP16_STP16.pdf		
<b>8.2 Qualification report and qualification results</b>	Available (see attachment)	<b>Issue Date</b>	2023-01-31

**9. Attachments (additional documentations)**

13903 Public product.pdf  
13903 RER 6088-1765-W-2022\_HTSSOP\_TSSOP 24 assembled in TFME\_ALED1262\_ALED1642\_STAP16\_STP16.pdf

**10. Affected parts**

10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	ALED1262ZTTR	

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